

Data Sheet August 2, 2006 FN8247.4

# Digitally Controlled Potentiometer (XDCP™)

The Intersil ISL90727 and ISL90728 are digitally controlled potentiometers (XDCP). Each device consists of a resistor array, wiper switches, and a control section. The wiper position is controlled by an I<sup>2</sup>C interface.

The potentiometer is implemented by a resistor array composed of 127 resistive elements and a wiper switching network. Between each element and at either end are tap points accessible to the wiper terminal. The position of the wiper element is controlled by the SDA and SCL inputs.

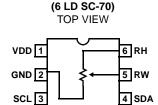
The device can be used in a wide variety of applications including:

- · Mechanical potentiometer replacement
- Transducer adjustment of pressure, temperature, position, chemical, and optical sensors
- · RF amplifier biasing
- · LCD brightness and contrast adjustment
- · Gain control and offset adjustment

### Features

- · Volatile Solid-State Potentiometer
- I<sup>2</sup>C Serial Bus Interface
- DCP Terminal Voltage, 2.7V to 5.5V
- Low Tempco
  - Rheostat 45 ppm/°C typical
  - Divider 15 ppm/°C typical
- 128 Wiper Tap Points
  - Wiper resistance 70Ω typ at V<sub>CC</sub> = 3.3V
- Low Power CMOS
  - Active current, 200µA max
  - Standby current, 500nA max
- Available R<sub>TOTAL</sub> Values = 50kΩ, 10kΩ
- · Power on Preset to Midscale
- Direct Replacement for AD5247
- Packaging
  - 6 Ld SC-70
- Pb-Free Plus Anneal Available (RoHS Compliant)

### **Pinout**



# Ordering Information

PART NUMBER (See Notes 1, 2)	PART MARKING	$R_{TOTAL}$ (k $\Omega$ )	TEMP RANGE (°C)	PACKAGE (Pb-Free)	PKG. DWG. #
ISL90727WIE627Z-TK	ANH	10	-40 to +85	6 Ld SC-70	P6.049
ISL90727UIE627Z-TK	ANI	50	-40 to +85	6 Ld SC-70	P6.049
ISL90728WIE627Z-TK	CCF	10	-40 to +85	6 Ld SC-70	P6.049

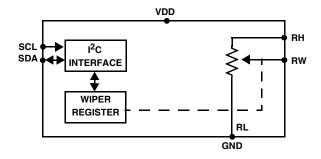
### NOTES:

- Intersil Pb-free plus anneal products employ special Pb-free material sets; molding compounds/die attach materials and 100% matte tin plate termination finish, which are RoHS compliant and compatible with both SnPb and Pb-free soldering operations. Intersil Pb-free products are MSL classified at Pb-free peak reflow temperatures that meet or exceed the Pb-free requirements of IPC/JEDEC J STD-020
- 2. ISL90727 has an I<sup>2</sup>C address 5Ch and ISL90728 has an I<sup>2</sup>C address 7Ch

# Pin Descriptions

PIN NUMBER	SYMBOL	DESCRIPTION
1	VDD	Supply Voltage
2	GND	Ground
3	SCL	Open drain Serial Clock input
4	SDA	Open drain Serial Data I/O
5	RW	Potentiometer Wiper Terminal
6	RH	Potentiometer High Terminal

# Block Diagram



# www.BDTIC.com/Intersil

### **Absolute Maximum Ratings**

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# **Recommended Operating Conditions**

Industrial	 	 4	40°C to +85°C
V <sub>CC</sub>	 	 	. 2.7V to 5.5\
Power Rating of Each DCP	 	 	5mV

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

### **Analog Specifications** Over recommended operating conditions unless otherwise stated.

SYMBOL	PARAMETER	TEST CONDITIONS		MIN	TYP (Note 3)	MAX	UNIT
R <sub>TOTAL</sub>	R <sub>H</sub> to R <sub>L</sub> Resistance	W option			10		kΩ
		U option			50		kΩ
	R <sub>H</sub> to R <sub>L</sub> Resistance Tolerance			-20		+20	%
R <sub>W</sub>	Wiper Resistance	V <sub>CC</sub> = 3.3V @ 25°C			85	200	Ω
C <sub>H</sub> /C <sub>L</sub> /C <sub>W</sub>	Potentiometer Capacitance				10/10/ 25		pF
I <sub>LkgDCP</sub>	Leakage on DCP Pins	Voltage at pin from GND to V <sub>CC</sub>			0.1		μΑ
VOLTAGE DIV	IDER MODE						
INL	Integral Non-linearity	IC com/I	nta	-1 <b>2 r</b> (	±0.2	1	LSB (Note 4)
DNL	Differential Non-linearity	Monotonic over all tap positions	W option		±0.1	1	LSB (Note 4)
			U option	-1	±0.1	1	LSB (Note 4)
ZSerror	Zero-scale Error	W option			1	3	LSB
(Note 5)		U option	0	0.5	1	(Note 4)	
FSerror	Full-scale Error	W option			-1	0	LSB
(Note 6)		U option	-1	-0.5	0	(Note 4)	
TC <sub>V</sub> (Note 12)	Ratiometric Temperature Coefficient	DCP Register set to 80 hex			±15		ppm/°C
RESISTOR MO	DDE						
RINL (Note 10)	Integral Non-linearity	DCP register set between 20 hex an Monotonic over all tap positions	d FF hex.	-2	±0.25	2	MI (Note 7)
RDNL (Note 9)	Differential Non-linearity	DCP register set between 20 hex and FF hex. Monotonic over all tap	W option	-1	±0.1	1	MI (Note 7)
		positions	U option	-1	±0.1	1	MI (Note 7)
Roffset (Note 8)	Offset	W option U option		0	1	3	MI (Note 7)
				0	0.5	1	MI (Note 7)
TC <sub>R</sub> (Notes 11, 12)	Resistance Temperature Coefficient	DCP register set between 20 hex and FF hex			±45		ppm/°C

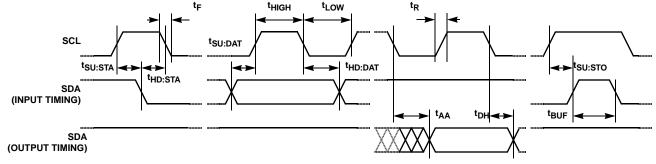
# **Operating Specifications**

SYMBOL	PARAMETER	TEST CONDITIONS	MIN	TYP (Note 3)	MAX	UNIT
I <sub>CC1</sub>	I <sub>CC1</sub> V <sub>CC</sub> Supply Current (Volatile write/read) f <sub>SCL</sub> = 400kHz; SDA = Ope Read and Volatile Write Star				200	μA
I <sub>SB</sub>	V <sub>CC</sub> Current (standby)	V <sub>CC</sub> = +5.5V, I <sup>2</sup> C Interface in Standby State			500	nA
I <sub>ComLkg</sub>	Common-Mode Leakage	Voltage at SDA pin to GND or V <sub>CC</sub>			3	μA
t <sub>DCP</sub> (Note 12)	DCP Wiper Response Time	SCL falling edge of last bit of DCP Data Byte to wiper change		500		ns
V <sub>CC</sub> Ramp	V <sub>CC</sub> Ramp Rate		0.2			V/ms
t <sub>D</sub>	Power-up Delay	V <sub>CC</sub> above Vpor, to DCP Initial Value Register recall completed, and I <sup>2</sup> C Interface in standby state			3	ms
SERIAL INTER	FACE SPECIFICATIONS					
V <sub>IL</sub>	SDA, and SCL Input Buffer LOW Voltage		-0.3		0.3* V <sub>CC</sub>	V
V <sub>IH</sub>	SDA, and SCL Input Buffer HIGH Voltage		0.7* V <sub>CC</sub>		V <sub>CC</sub> +	V
Hysteresis	SDA and SCL Input Buffer Hysteresis		0.05* V <sub>CC</sub>			V
$V_{OL}$	SDA Output Buffer LOW Voltage, Sinking 4mA		0		0.4	V
Cpin (Note 14)	SDA, and SCL Pin Capacitance				10	pF
f <sub>SCL</sub>	SCL Frequency				400	kHz
t <sub>IN</sub>	Pulse Width Suppression Time a SDA Ana SCA Inputs	An pulse narrower than the max spec is suppressed.	rs	e i I	50	ns
t <sub>AA</sub>	SCL Falling Edge to SDA Output Data Valid	SCL falling edge crossing 30% of $\rm V_{CC}$ , until SDA exits the 30% to 70% of $\rm V_{CC}$ window.			900	ns
<sup>t</sup> BUF	Time the Bus Must be Free Before the Start of a New Transmission	SDA crossing 70% of $V_{CC}$ during a STOP condition, to SDA crossing 70% of $V_{CC}$ during the following START condition.	1300			ns
t <sub>LOW</sub>	Clock LOW Time	Measured at the 30% of V <sub>CC</sub> crossing.	1300			ns
tHIGH	Clock HIGH Time	Measured at the 70% of V <sub>CC</sub> crossing.	600			ns
<sup>t</sup> SU:STA	START Condition Setup Time	SCL rising edge to SDA falling edge. Both crossing 70% of $V_{CC}$ .	600			ns
<sup>t</sup> HD:STA	START Condition Hold Time	From SDA falling edge crossing 30% of $\rm V_{CC}$ to SCL falling edge crossing 70% of $\rm V_{CC}$ .	600			ns
<sup>t</sup> SU:DAT	Input Data Setup Time	From SDA exiting the 30% to 70% of V $_{\rm CC}$ window, to SCL rising edge crossing 30% of V $_{\rm CC}$	100			ns
<sup>t</sup> HD:DAT	Input Data Hold Time	From SCL rising edge crossing 70% of $V_{CC}$ to SDA entering the 30% to 70% of $V_{CC}$ window.	0			ns
tsu:sto	STOP Condition Setup Time	From SCL rising edge crossing 70% of $V_{CC}$ , to SDA rising edge crossing 30% of $V_{CC}$ .	600			ns
<sup>t</sup> HD:STO	STOP Condition Hold Time for Read, or Volatile Only Write	From SDA rising edge to SCL falling edge. Both crossing 70% of $\rm V_{CC}$ .	600			ns
t <sub>DH</sub>	Output Data Hold Time	From SCL falling edge crossing 30% of $\rm V_{CC}$ , until SDA enters the 30% to 70% of $\rm V_{CC}$ window.	0			ns
t <sub>R</sub> (Note 14)	SDA and SCL Rise Time	From 30% to 70% of V <sub>CC</sub>	20 + 0.1 * Cb		250	ns

### Operating Specifications (Continued)

SYMBOL	PARAMETER	TEST CONDITIONS	MIN	TYP (Note 3)	MAX	UNIT
t <sub>F</sub> (Note 14)	SDA and SCL Fall Time	From 70% to 30% of V <sub>CC</sub>	20 + 0.1 * Cb		250	ns
Cb (Note 14)	Capacitive Loading of SDA or SCL	Total on-chip and off-chip	10		400	pF
Rpu (Note 14)	SDA and SCL Bus Pull-up Resistor Off-chip	Maximum is determined by $t_R$ and $t_F$ . For Cb = 400pF, max is about 2~2.5kΩ. For Cb = 40pF, max is about 15~20kΩ	1			kΩ

### SDA vs SCL Timing



### NOTES:

- 3. Typical values are for  $T_A = 25^{\circ}C$  and 3.3V supply voltage.
- 4. LSB: [V(R<sub>W</sub>)<sub>127</sub> V(R<sub>W</sub>)<sub>0</sub>]/127. V(R<sub>W</sub>)<sub>127</sub> and V(R<sub>W</sub>)<sub>0</sub> are V(R<sub>W</sub>) for the DCP register set to FF hex and 00 hex respectively. LSB is the incremental voltage when changing from one tap to an adjacent tap.
- 5. ZS error =  $V(R_W)_0/LSB$ .
- 6. FS error = [V(FW)/27+Voc/LSB. B TO THE METERS OF THE DOF register set to FF nex and 00 fbx respectively
- MI = |R<sub>127</sub> R<sub>0</sub>|/127. R<sub>127</sub> and R<sub>0</sub> are the measured resistances for the DOF register set to FF hex and 00 hex respectively. Roffset = R<sub>0</sub>/MI, when measuring between R<sub>W</sub> and R<sub>L</sub>.
- 8. Roffset =  $R_{127}/MI$ , when measuring between  $R_W$  and  $R_H$ .
- 9.  $RDNL = (R_i R_{i-1})/MI 1$ , for i = 32 to 127.
- 10. RINL =  $[R_i (MI \cdot i) R_0]/MI$ , for i = 32 to 127.
- 11.  $TC_{R} = \frac{[Max(Ri) Min(Ri)]}{[Max(Ri) + Min(Ri)]/2} \times \frac{10^{6}}{125^{\circ}C} \text{ for } i = 32 \text{ to } 127, T = -40^{\circ}C \text{ to } 85^{\circ}C. \\ Max() \text{ is the maximum value of the resistance and Min () is the maximum value of the resistance over the temperature range.}$
- 12. This parameter is not 100% tested.
- 13.  $V_{IL} = 0V$ ,  $V_{IH} = V_{CC}$ .
- 14. These are I<sup>2</sup>C-specific parameters and are not directly tested. However, they are used in the device testing to validate specifications.

# **Principles of Operation**

The ISL90727 and ISL90728 are integrated circuits incorporating one DCP with its associated registers and an  $I^2C$  serial interface providing direct communication between a host and the potentiometer.

### DCP Description

The DCP is implemented with a combination of resistor elements and CMOS switches. The physical ends of the DCP are equivalent to the fixed terminals of a mechanical potentiometer ( $R_H$  and  $R_L$  pins). The  $R_W$  pin of the DCP is connected to intermediate nodes, and is equivalent to the wiper terminal of a mechanical potentiometer. The position of the wiper terminal within the DCP is controlled by a 7-bit volatile Wiper Register (WR). The DCP has its own WR. When the WR of the DCP contains all zeroes (WR<6:0> = 00h), its wiper

terminal ( $R_W$ ) is closest to its "Low" terminal ( $R_L$ ). When the WR of the DCP contains all ones (WR<6:0> = 7Fh), its wiper terminal ( $R_W$ ) is closest to its "High" terminal ( $R_H$ ). As the value of the WR increases from all zeroes (00h) to all ones (127 decimal), the wiper moves monotonically from the position closest to  $R_L$  to the position closest to  $R_H$ . At the same time, the resistance between  $R_W$  and  $R_L$  increases monotonically, while the resistance between  $R_H$  and  $R_W$  decreases monotonically.  $R_L$  is connected to the GND pin of the device, so the wiper movement will always be relative to  $R_I$ .

While the ISL90727 and ISL90728 are being powered up, the WR is reset to 40h (64 decimal), which locates  $R_W$  roughly at the center between  $R_L$  and  $R_H. \\$ 

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The WR and IVR can be read or written directly using the I<sup>2</sup>C serial interface as described in the following sections.

# **1<sup>2</sup>C Serial Interface**

The ISL90727 and ISL90728 support bidirectional bus oriented protocol. The protocol defines any device that sends data onto the bus as a transmitter and the receiving device as the receiver. The device controlling the transfer is a master and the device being controlled is the slave. The master always initiates data transfers and provides the clock for both transmit and receive operations. Therefore, the ISL90727 and ISL90728 operate as slave devices in all applications.

All communication over the I<sup>2</sup>C interface is conducted by sending the MSB of each byte of data first.

### **Protocol Conventions**

Data states on the SDA line can change only during SCL LOW periods. SDA state changes during SCL HIGH are reserved for indicating START and STOP conditions (See Figure 1). On power-up of the ISL90727 and ISL90728, the SDA pin is in the input mode.

All I<sup>2</sup>C interface operations must begin with a START condition, which is a HIGH to LOW transition of SDA while SCL is HIGH. The ISL90727 and ISL90728 continuously monitor the SDA and SCL lines for the START condition and do not respond to any command until this condition is root (See Figure 1) A START condition is condition is root (See Figure 1).

All I<sup>2</sup>C interface operations must be terminated by a STOP condition, which is a LOW to HIGH transition of SDA while SCL is HIGH (See Figure 1).

An ACK, Acknowledge, is a software convention used to indicate a successful data transfer. The transmitting device, either master or slave, releases the SDA bus after transmitting eight bits. During the ninth clock cycle, the receiver pulls the SDA line LOW to acknowledge the reception of the eight bits of data (See Figure 2).

The ISL90727 and ISL90728 respond with an ACK after recognition of a START condition followed by a valid Identification Byte, and once again after successful receipt of an Address Byte. The ISL90727 and ISL90728 also respond with an ACK after receiving a Data Byte of a write operation. The master must respond with an ACK after receiving a Data Byte of a read operation.

A valid Identification Byte contains 0101110 as the seven MSBs for the ISL90727 and 0111110 as the seven MSBs for the ISL90728. The LSB in the Read/Write bit. Its value is "1" for a Read operation, and "0" for a Write operation (See Table 1)

**TABLE 1. IDENTIFICATION BYTE FORMAT** 

ISL90728	0	1	1	1	1	1	0	R/W
ISL90727	0	1	0	1	1	1	0	R/W

MSB LSB

# Write Operation

A Write operation requires a START condition, followed by a valid Identification Byte, a valid Address Byte, a Data Byte, and a STOP condition. After each of the three bytes, the ISL90727 and ISL90728 respond with an ACK. At this time, the device enters its standby state (See Figure 3).

### **Data Protection**

A valid Identification Byte, Address Byte, and total number of SCL pulses act as a protection of both volatile and non-volatile registers. During a Write sequence, the Data Byte is loaded into an internal shift register as it is received. If the Address Byte is 0, the Data Byte is transferred to the Wiper Register (WR) at the falling edge of the SCL pulse that loads the last bit (LSB) of the Data Byte. If an address other than 00h or an invalid slave address is sent, then the device will respond with no ACK.

## **Read Operation**

A Read operation consist of a three byte instruction followed by one or more Data Bytes (See Figure 4). The master names the operation is in the rollowing sequence: a START, the Identification byte with the R/W bit set to "0", an Address Byte, a second START, and a second Identification byte with the R/W bit set to "1". After each of the three bytes, the ISL90727 and ISL90728 respond with an ACK. Then the ISL90727 and ISL90728 transmit the Data Byte as long as the master responds with an ACK during the SCL cycle following the eighth bit of each byte. The master then terminates the read operation (issuing a STOP condition) following the last bit of the Data Byte (See Figure 4).

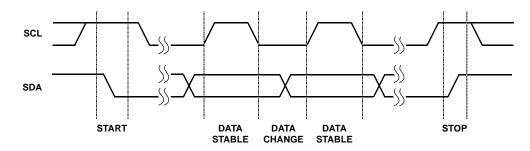


FIGURE 1. VALID DATA CHANGES, START AND STOP CONDITIONS

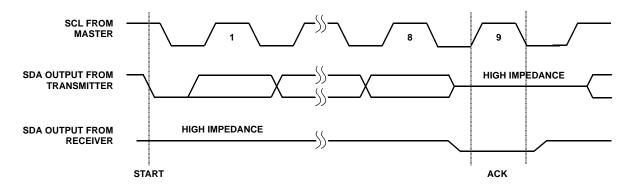


FIGURE 2. ACKNOWLEDGE RESPONSE FROM RECEIVER

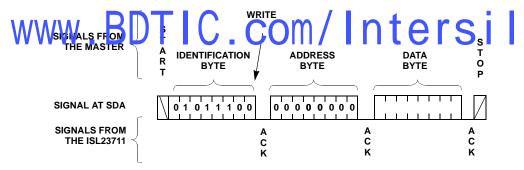


FIGURE 3. BYTE WRITE SEQUENCE (ISL90727 VERSION SHOWN)

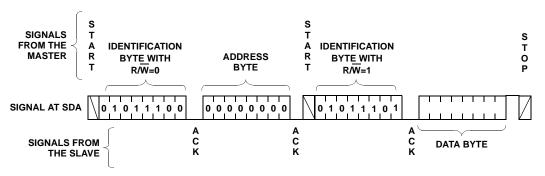


FIGURE 4. READ SEQUENCE (ISL90727 VERSION SHOWN)

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# Small Outline Transistor Plastic Packages (SC70-6)

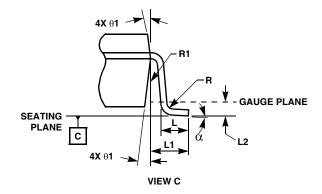
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P6.049
6 LEAD SMALL OUTLINE TRANSISTOR PLASTIC PACKAGE

	INC	HES	MILLIN		
SYMBOL	MIN	MAX	MIN	MAX	NOTES
Α	0.031	0.043	0.80	1.10	-
A1	0.000	0.004	0.00	0.10	-
A2	0.031	0.039	0.00	1.00	-
b	0.006	0.012	0.15	0.30	-
b1	0.006	0.010	0.15	0.25	
С	0.003	0.009	0.08	0.22	6
c1	0.003	0.009	0.08	0.20	6
D	0.073	0.085	1.85	2.15	3
E	0.071	0.094	1.80	2.40	-
E1	0.045	0.053	1.15	1.35	3
е	0.025	6 Ref	0.65	Ref	-
e1	0.051	2 Ref	1.30	Ref	-
L	0.010	0.018	0.26	0.46	4
L1	0.017	' Ref.	0.420	Ref.	
L2	0.006	BSC	0.15 BSC		
N	6	3	6		5
R	0.004	-	0.10	-	
R1	0.004	0.010	0.15	0.25	
<b>n</b> m /	0°	<b>1</b> 8	re	8°	-
					Rev. 2 9/03

### NOTES

- 1. Dimensioning and tolerance per ASME Y14.5M-1994.
- 2. Package conforms to EIAJ SC70 and JEDEC MO203AB.
- 3. Dimensions D and E1 are exclusive of mold flash, protrusions, or gate burrs.
- 4. Footlength L measured at reference to gauge plane.
- 5. "N" is the number of terminal positions.
- 6. These Dimensions apply to the flat section of the lead between 0.08mm and 0.15mm from the lead tip.
- 7. Controlling dimension: MILLIMETER. Converted inch dimensions are for reference only



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